

## Description

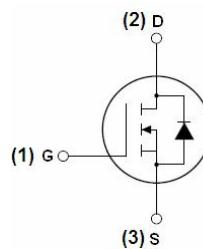
The 60N02 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

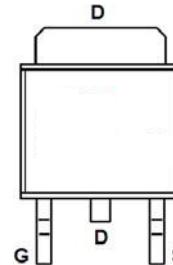
- $V_{DS} = 20V, I_D = 60A$
- $R_{DS(ON)} < 7m\Omega @ V_{GS}=4.5V$
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation

## Application

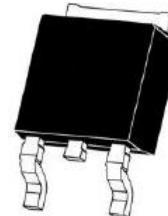
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



Schematic diagram



Marking and pin assignment



TO-252-2L top view

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current-Continuous	$I_D$	60	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D (100^\circ C)$	42	A
Pulsed Drain Current	$I_{DM}$	210	A
Maximum Power Dissipation	$P_D$	60	W
Derating factor		0.48	W/ $^\circ C$
Single pulse avalanche energy (Note 5)	$E_{AS}$	200	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	$^\circ C$

**Thermal Characteristic**

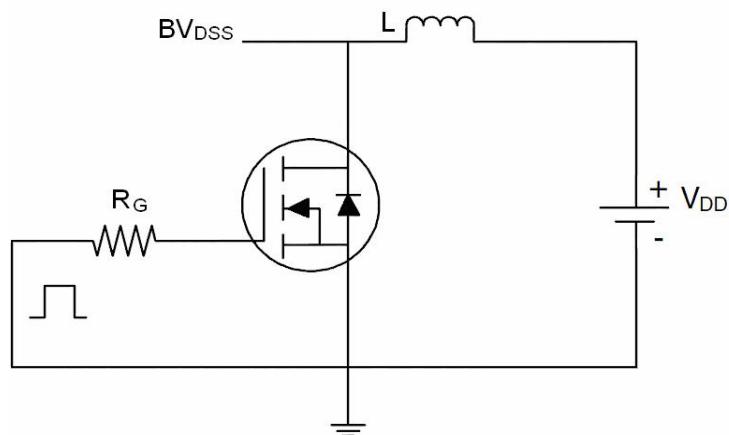
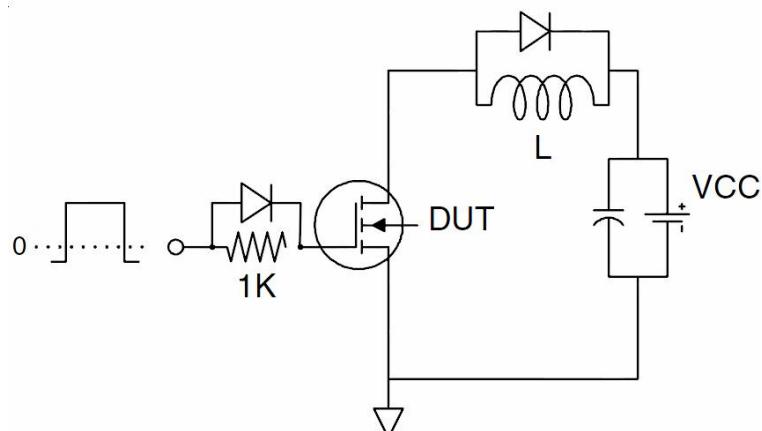
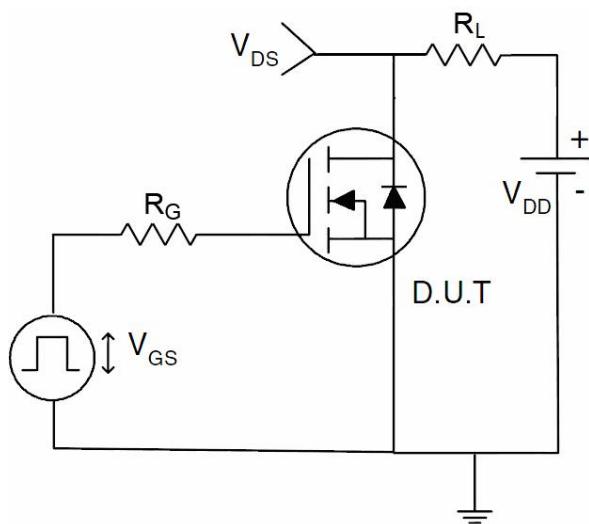
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	2.1	°C/W
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**Electrical Characteristics ( $T_c=25^\circ C$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>On Characteristics (Note 3)</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.75	1.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=20A$	-	6	7	$m\Omega$
		$V_{GS}=2.5V, I_D=15A$		7	9	$m\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=10V, I_D=20A$	15	-	-	S
<b>Dynamic Characteristics (Note 4)</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V, F=1.0MHz$	-	2000	-	PF
Output Capacitance	$C_{oss}$		-	500	-	PF
Reverse Transfer Capacitance	$C_{rss}$		-	200	-	PF
<b>Switching Characteristics (Note 4)</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V, I_D=2A, R_L=1\Omega$ $V_{GS}=4.5V, R_G=3\Omega$	-	6.4	-	nS
Turn-on Rise Time	$t_r$		-	17.2	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	29.6	-	nS
Turn-Off Fall Time	$t_f$		-	16.8	-	nS
Total Gate Charge	$Q_g$	$V_{DS}=10V, I_D=20A, V_{GS}=10V$	-	27	-	nC
Gate-Source Charge	$Q_{gs}$		-	6.5	-	nC
Gate-Drain Charge	$Q_{gd}$		-	6.4	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$V_{SD}$	$V_{GS}=0V, I_S=10A$	-		1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$I_S$		-	-	60	A
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ C, IF = 20A$ $di/dt = 100A/\mu s^{(Note 3)}$	-	25	-	nS
Reverse Recovery Charge	$Q_{rr}$		-	24	-	nC
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
  2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
  3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
  4. Guaranteed by design, not subject to production
5. E<sub>AS</sub> condition :  $T_j=25^\circ C, V_{DD}=10V, V_G=10V, L=0.5mH, R_g=25\Omega$ ,

**Test circuit**
**1) E<sub>AS</sub> Test Circuit**

**2) Gate Charge Test Circuit**

**3) Switch Time Test Circuit**


### Typical Electrical and Thermal Characteristics (Curves)

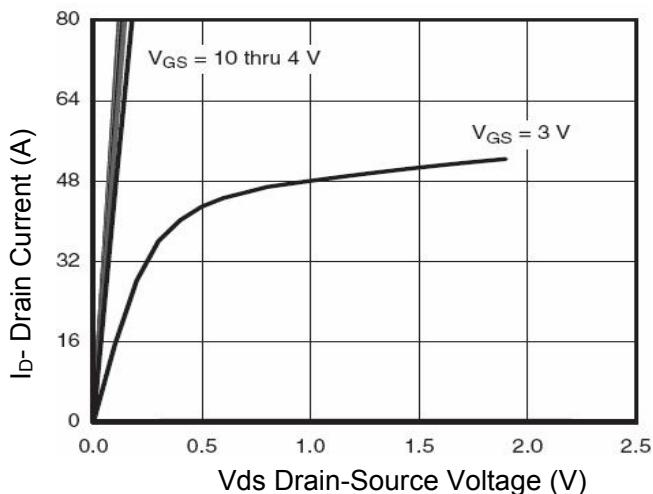


Fig.1 Typical Output Characteristics

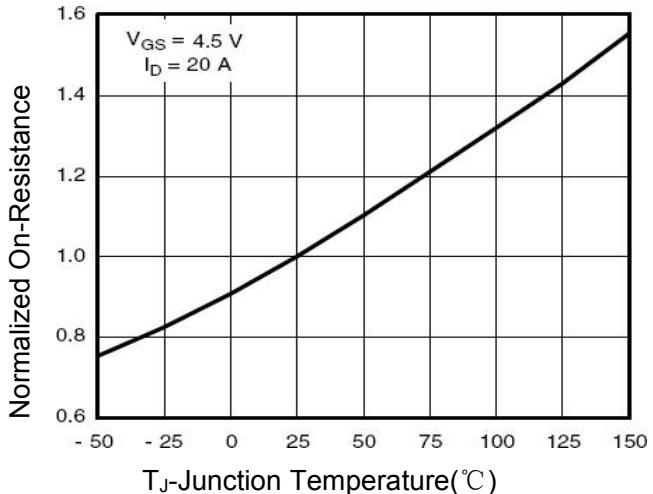


Figure 4 Rdson-JunctionTemperature

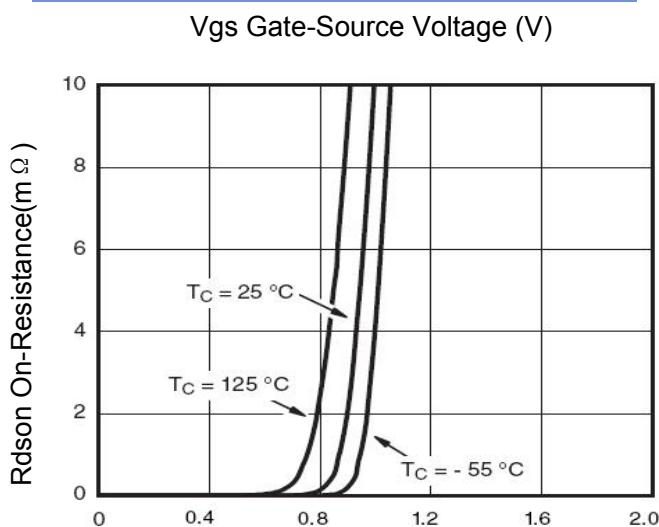


Figure 2 Transfer Characteristics

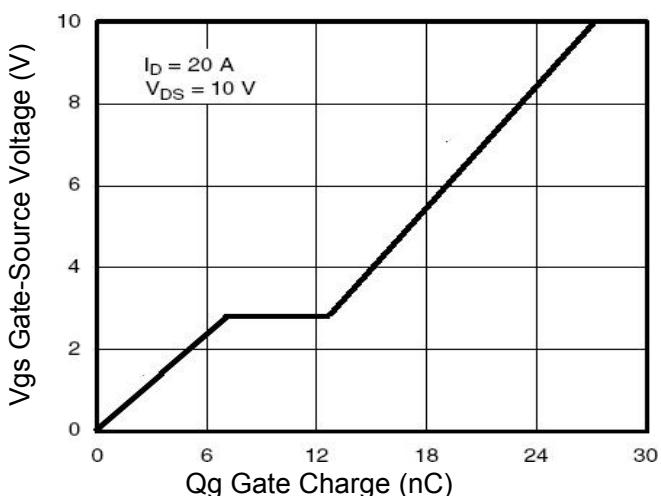


Figure 5 Gate Charge

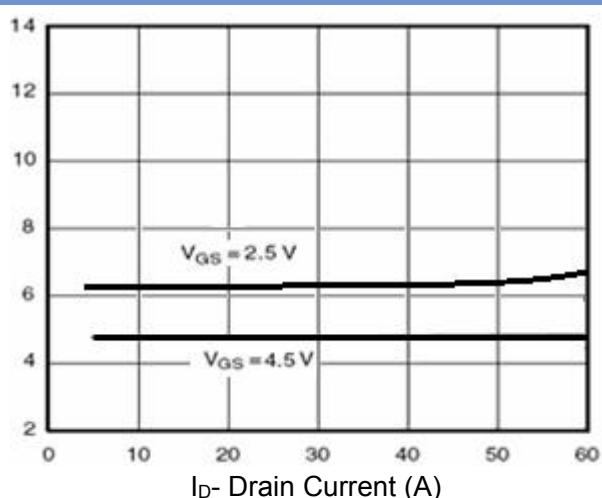


Figure 3 Rdson- Drain Current

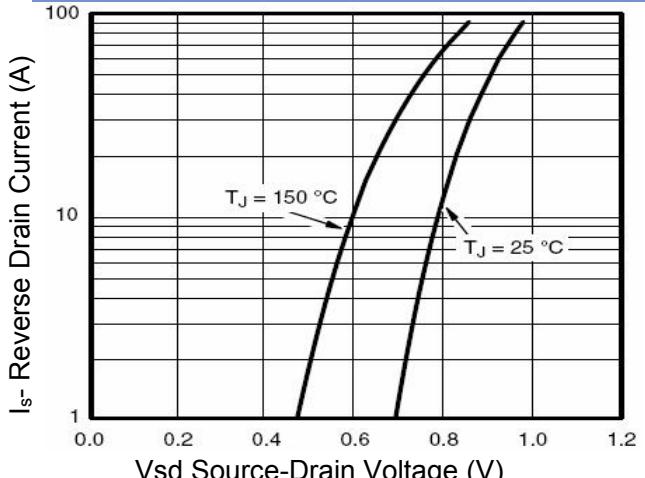
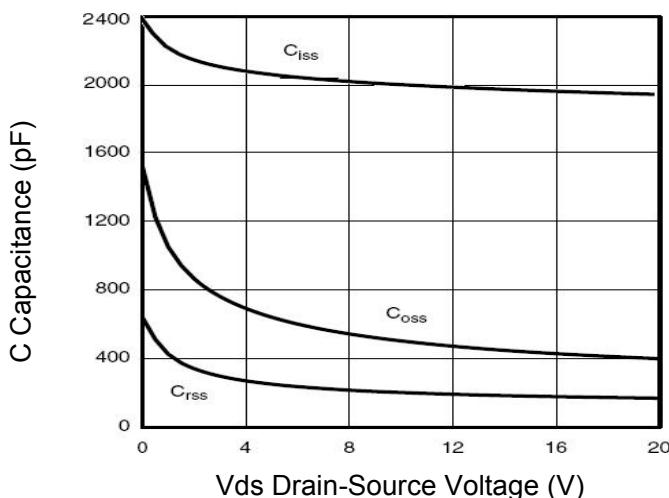
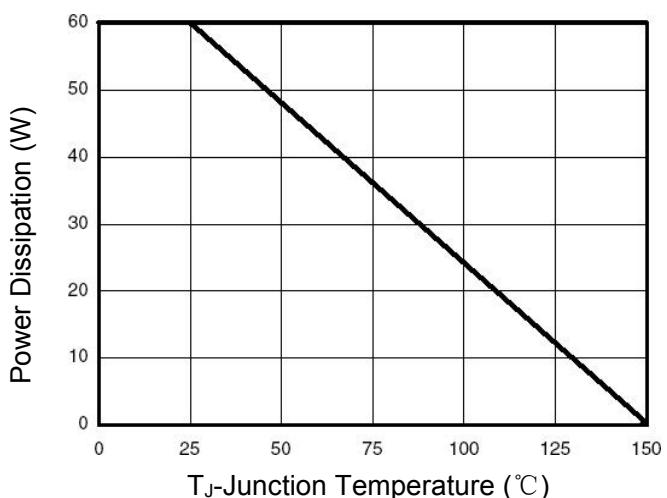
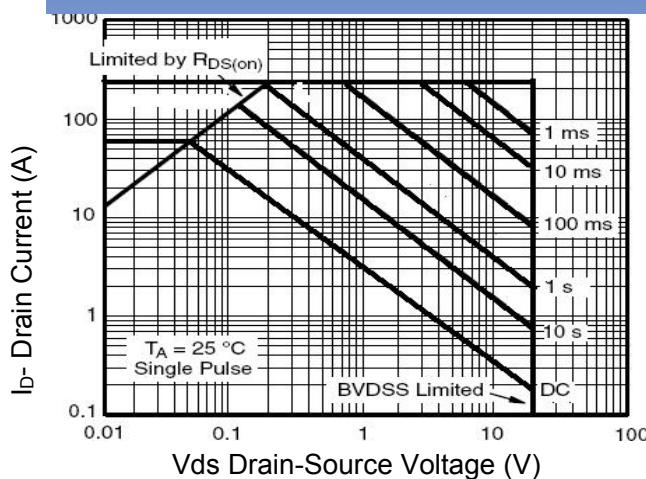
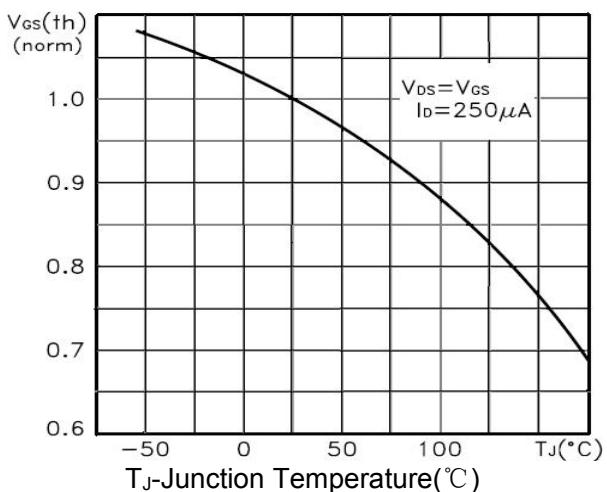
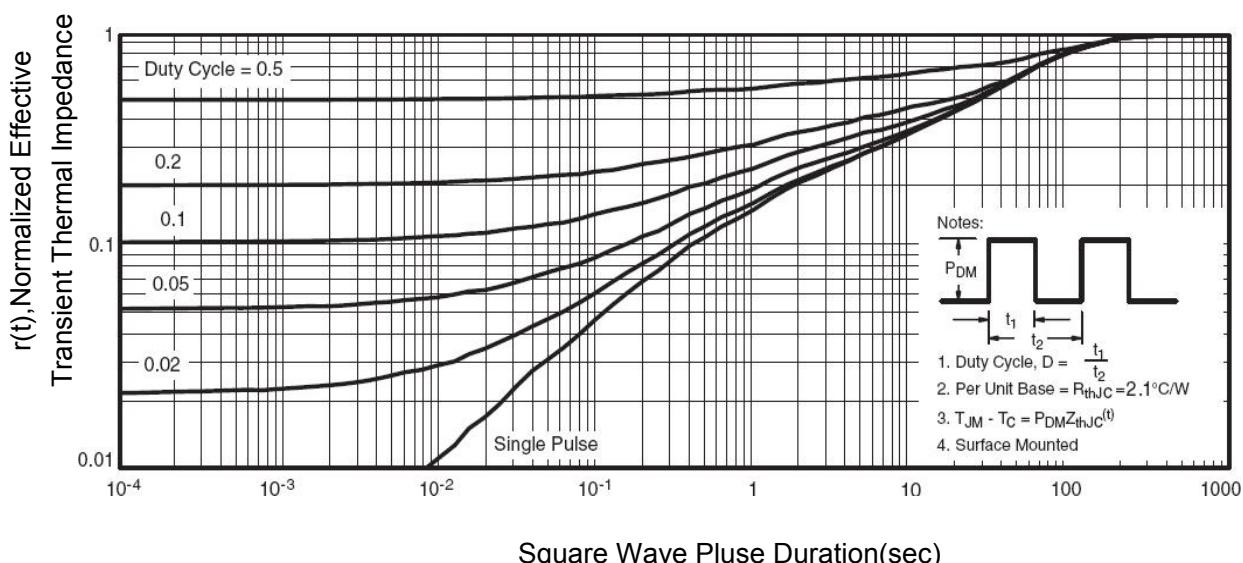


Figure 6 Source- Drain Diode Forward


**Figure 7 Capacitance vs Vds**

**Figure 9 Power De-rating**

**Figure 8 Safe Operation Area**

**Figure 10 V<sub>GS(th)</sub> vs Junction Temperature**

**Figure 11 Normalized Maximum Transient Thermal Impedance**